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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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2PS18012E44G38553



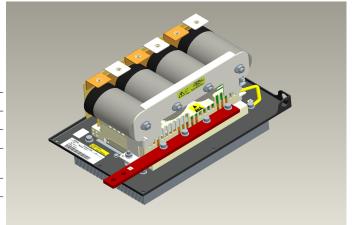
Preliminary data

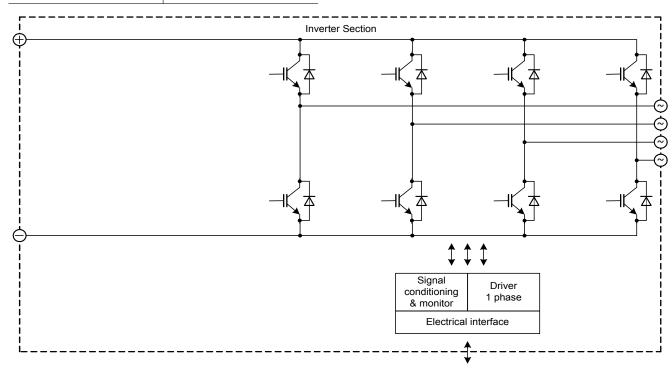
General information

IGBT Stack for typical voltages of up to 400 V_{RMS} Rated output current 770 A_{RMS}

- · Solar power · Motor drives
- · High power converter
- $\begin{array}{l} \cdot \ 62mm \ power \ module \\ \cdot \ Trenchstop^{\text{TM}} \ IGBT4 \end{array}$

Topology	1/2 B2I
Application	Inverter
Load type	Resistive, inductive
Semiconductor (Inverter Section)	4x FF450R12KE4
DC Link	1.6 mF
Heatsink	Forced air cooled (fan not included)
Implemented sensors	Current, temperature
Driver signals IGBT	Electrical
Approvals	UL 508C
Sales - name	2PS18012E4FG38553
SP - No.	SP001062698





prepared by: OW	date of publication: 2014-11-18
approved by: YZ	revision: 2.0

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Absolute maximum rated values

Collector-emitter voltage	IGBT; T _{vj} = 25°C	V _{CES}	1200	V
Repetitive peak reverse voltage	Diode; T _{vj} = 25°C	V_{RRM}	1200	V
DC link voltage		V_{DC}	1000	V
Insulation management	according to installation height of 2000 m	V _{line}	500	V _{RMS}
Insulation test voltage	according to EN 50178, f = 50 Hz, t = 1 s	V _{ISOL}	2.5	kV _{RMS}
Repetitive peak collector current inverter section (IGBT)	$t_p = 1 \text{ ms}$	I _{CRM2}	2560	Α
Repetitive peak forward current inverter section (Diode)	$t_p = 1 \text{ ms}$	I _{FRM2}	2440	А
Continuous current inverter section		I _{AC2}	820	A _{RMS}
Junction temperature	under switching conditions	T_{vjop}	150	°C
Switching frequency inverter section	limited due to snubber caps	f _{sw2}	3	kHz

Notes

Further maximum ratings are specified in the following dedicated sections

Characteristic values

DC Link			min.	typ.	max.	
Rated voltage		V _{DC}		650	1000	V
Capacitor	1 s, 4 p, rated tol. 10 %	C _{DC}		1.6		mF
Maximum ripple current	per device, T _{amb} = 55 °C	I _{ripple}			49	A _{RMS}

Notes

Activ clamping diodes not implemented, max. DC link voltage for short circuit protection 500V Max. DC link voltage under switching conditions 1000V up to 300A. (T junction > 25°C)

Inverter Section			min.	typ.	max.	
Rated continuous current	$ \begin{vmatrix} V_{DC} = 650 \text{ V}, \ V_{AC} = 400 \ V_{RMS}, \ cos(\phi) = 0.85, \\ f_{AC \text{ sine}} = 50 \ Hz, \ f_{sw} = 3000 \ Hz, \ T_{inlet} = 50 ^{\circ}C, \ T_{j} \leq 125 \ ^{\circ}C \ \ \label{eq:VDC} $	I _{AC}		770		A _{RMS}
Rated continuous current for 150% overload capability	$I_{AC~150\%}$ = 820 A _{RMS} , $t_{on~over}$ = 60 s, $T_{j} \le$ 125 °C	I _{AC} over1			550	A _{RMS}
Rated continuous current for 150% overload capability	$I_{AC~150\%}$ = 820 A _{RMS} , $t_{on~over}$ = 3 s, $T_{j} \le$ 125 °C	I _{AC over2}			630	Arms
Over current shutdown	within 15 μs	I _{AC OC}		1280		A _{peak}
Power losses	I_{AC} = 400 A, V_{DC} = 650 V, $cos(φ)$ = 0.85, $f_{AC sine}$ = 50 Hz, f_{sw} = 3000 Hz, T_{inlet} = 50 °C, T_{j} ≤ 125 °C	P _{loss}		5600		W

Notes

Maximum junction temperature limited to 125°C under all operating conditions

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kg

Controller interface

Driver and interface board	er and interface board ref. to separate Application Note			DR240		
			min.	typ.	max.	
Auxiliary voltage		V _{aux}	18	24	30	V
Auxiliary power requirement	V _{aux} = 24 V	Paux			40	W
Digital input level	resistor to GND 10 kΩ, capacitor to GND 1 nF	V _{in low}	0		4	V
		V _{in high}	11		15	V
Digital output level	open collector, logic low = no fault, max. 15 mA	V _{out low}	0		1.5	V
		V _{out high}		15		V
Analog current sensor output inverter section	load max 5 mA, @ 770 A _{RMS}	VIU ana2 VIV ana2 VIW ana2	6	6.1	6.2	V
Over temperature shutdown inverter section	load max 5 mA, @T _{NTC} = 86 °C	V _{Error OT2}	10.8	11	11.2	V

System data min. typ. max. according to IEC 61800-3 at named power V_{Burst} kV 2 **EMC** robustness interfaces control V_{Burst} 1 kV V_{surge} aux (24V) 1 kV $^{\circ}\text{C}$ Storage temperature T_{stor} -40 80 Operational ambient PCB, DC link capacitor, bus bar, excluding cooling °C -25 60 $T_{op\; amb}$ temperature Cooling air velocity PCB, DC link capacitor, bus bar, standard atmosphere $V_{\text{air}} \\$ 2 m/s Humidity no condensation Rel. F 0 85 % Vibration according to IEC 60721 m/s² according to IEC 60721 Shock m/s² Protection degree IP00 2 Pollution degree Dimensions 284 472 287 width x depth x height mm

Weight Notes

System data valid for continuous operation

Heatsink air cooled			min.	typ.	max.	
Air flow	T _{air} = 20 °C, P _{air} = 1013 hPa, dry and dust free, measured at the side of the heat sink according to DIN 41882	ΔV/Δt	500			m³/h
Air pressure drop	at min. air flow	Δр		200		Pa
Air inlet temperature		T _{inlet}	-30		55	°C

Notes

Conditions are standard Infineon characterization for heatsinks.

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Overview of optional components	Unit 1	Inverter Section	Unit 3
Parallel interface board			
Optical interface board			
Voltage sensor			
Current sensor		×	
Temperature sensor		×	
Temperature simulation			
DC link capacitors		×	
Data cable for control signals			
Fan			
Collector-emitter Active Clamping			
Snubber capcitors		×	

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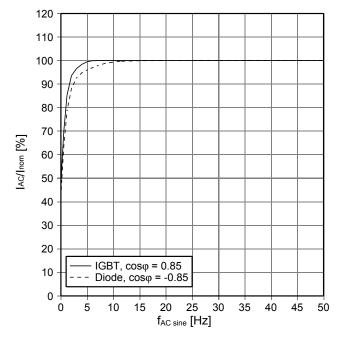
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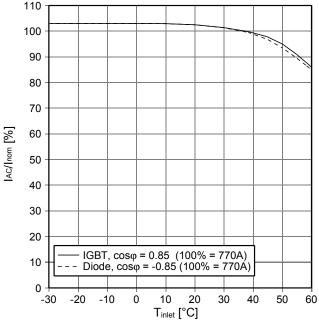
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 $f_{AC~sine}$ - derating curve IGBT (motor), Diode (generator) V_{DC} = 650 V, V_{AC} = 400 $V_{RMS},\,f_{sw}$ = 3 kHz, $cos\phi$ = $\pm0.85,\,$ T_{inlet} = 50 °C and nom. cooling conditions

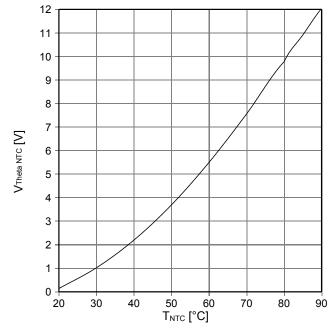
$$\begin{split} &T_{\text{inlet}} \text{ - derating curve IGBT (motor), Diode (generator)} \\ &V_{\text{DC}} = 650 \text{ V, V}_{\text{AC}} = 400 \text{ V}_{\text{RMS}}, f_{\text{AC sine}} = 50 \text{ Hz, cos}\phi = \pm 0.85, \\ &T_{\text{inlet}} = 50 \text{ °C and nom. cooling conditions} \end{split}$$



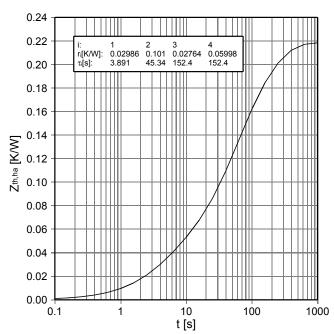
Analog temperature sensor output $V_{\text{Theta NTC}}$ Sensing NTC of heatsink



 $Z_{\text{th,ha}}$ - thermal impedance heatsink to ambient per switch nom. cooling conditions



prepared by: OW date of publication: 2014-11-18 approved by: YZ revision: 2.0



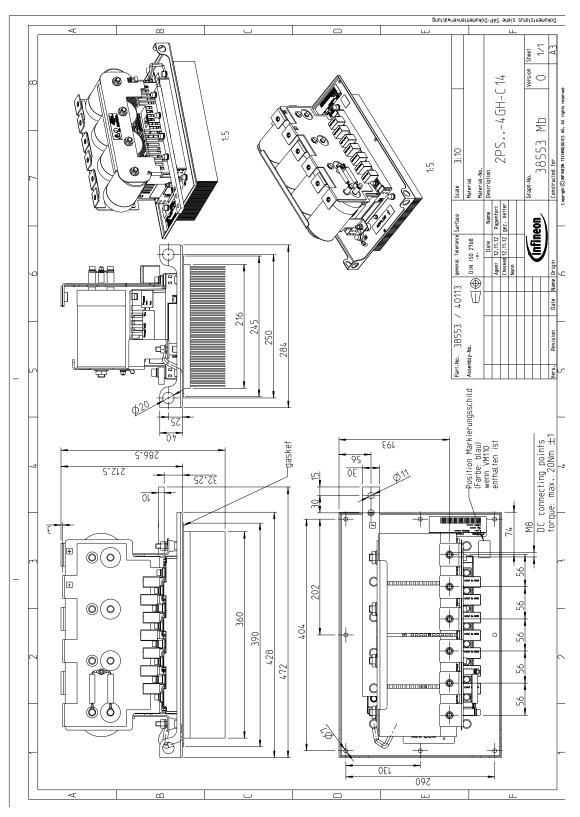
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Mechanical drawing



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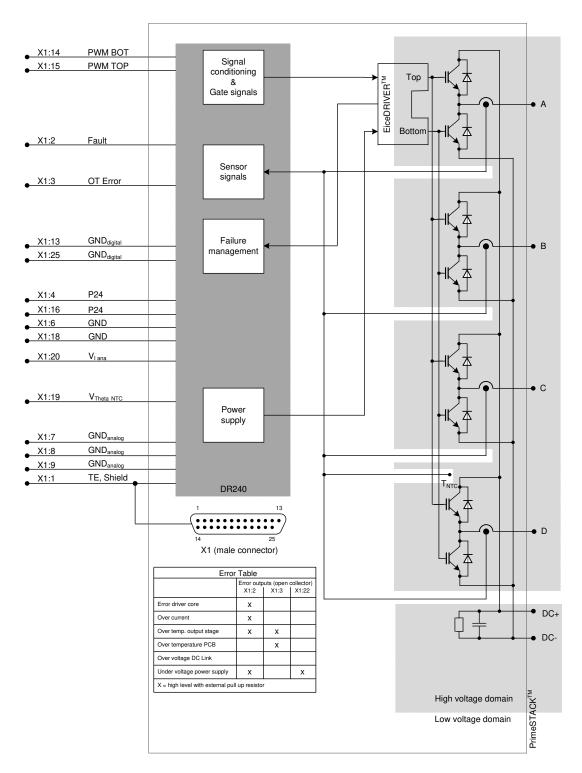
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Circuit diagram



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- to perform joint Risk and Quality Assessments;
- the conclusion of Quality Agreements;
- to establish joint measures of an ongoing product survey, and that we may make delivery depended on the realization of any such measures.

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Prior to installation and operation, all safety notices and warnings and all warning signs attached to the equipment have to be carefully read. Make sure that all warning signs remain in a legible condition and that missing or damaged signs are replaced. To installation and operation, all safety notices and warnings and all warning signs attached to the equipment have to be carefully read. Make sure that all warning signs remain in a legible condition and that missing or damaged signs are replaced.

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